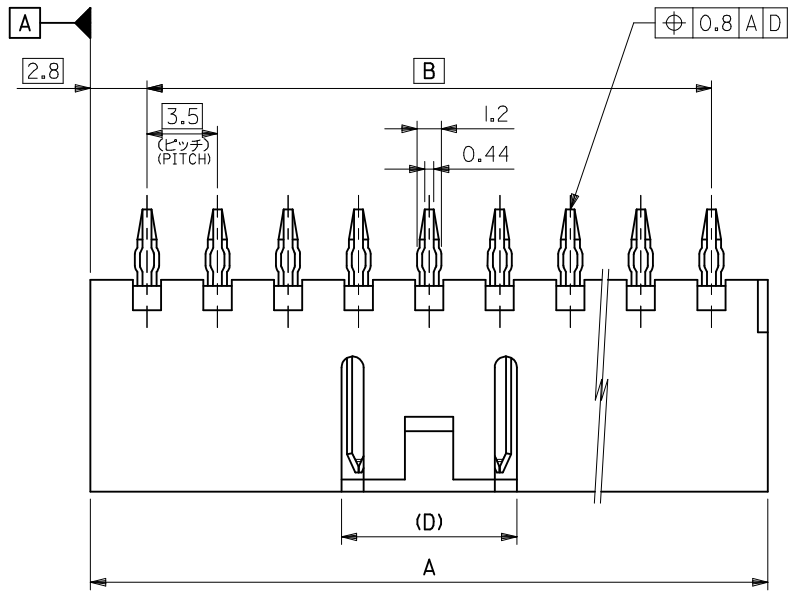
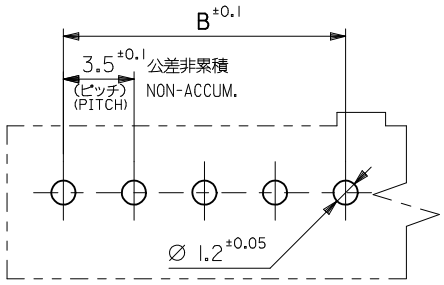
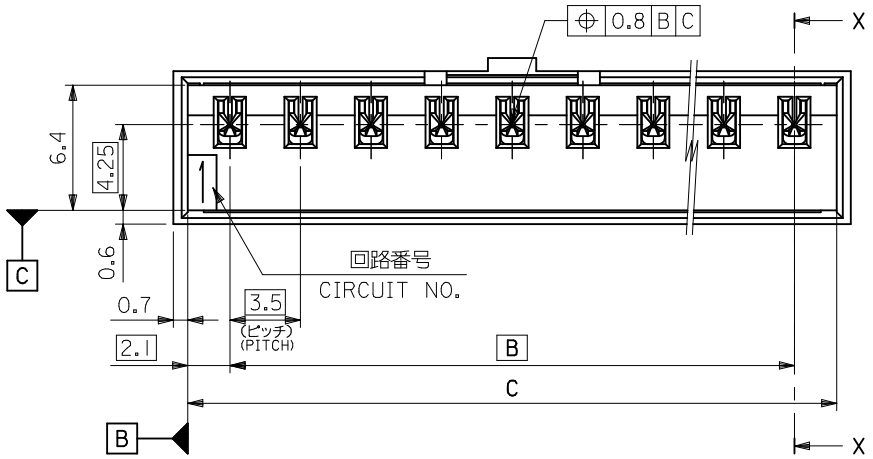


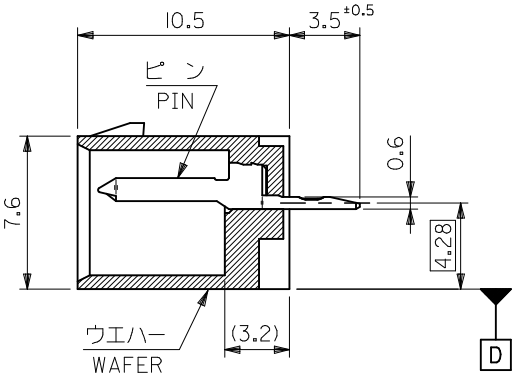


基板取付穴推奨寸法（参考）（t＝1．6）
RECOMMENDED P.C. BOARD HOLE DIM. (REF.)

注記 NOTES

1. 嵌合相手：51067 シリーズ
   MATE WITH : 51067 SERIES
2. 材質
   MATERIAL
   ウエハー：PBTP（ガラス15%入り）、UL94V-0
   WAFER : PBTP (G.F 15%), UL94V-0
   ピン　：黄銅、ニッケル下地　錫メッキ（t =0.254）
   PIN　: BRASS
   TIN OVER NICKEL PLATING (t=0.254)
3. 本製品は　53258-**20　の鉛フリー品である。
   THIS PRODUCT IS LEAD FREE OF 53258-**20.
4. メッキ仕様
   TERMINAL PLATING
   表面メッキ　：　スズメッキ　1μm MIN.
   SURFACE PLATE : TIN　1μm MIN.
   下地メッキ　：　ニッケルメッキ　1μm MIN.
   UNDER PLATE :　NICKEL 1μm MIN.





SECT-X-X

8.7	53.2	49.0	54.6	53258-1529	15
	49.7	45.5	51.1	-1429	14
	46.2	42.0	47.6	-1329	13
	42.7	38.5	44.1	-1229	12
	39.2	35.0	40.6	-1129	11
	35.7	31.5	37.1	-1029	10
	32.2	28.0	33.6	-0929	9
	28.7	24.5	30.1	-0829	8
	25.2	21.0	26.6	-0729	7
	21.7	17.5	23.1	-0629	6
	18.2	14.0	19.6	-0529	5
8.7	14.7	10.5	16.1	-0429	4
6.1	11.2	7.0	12.6	-0329	3
6.1	7.7	3.5	9.1	53258-0229	2
(D)	C	B	A	MATERIAL NO.	CKT. 極数

MODEL NO. 53258-**29

MATERIAL 材料
注記参照
SEE NOTES

REVISED
EC NO: J2007-0432 2006/08/11
DRWN:KSAITO01 2006/08/21
CH'KD:THARUYAMA
APPR:NUKITA 2006/08/23
DESCRIPTION
REV
A

GENERAL TOLERANCES (UNLESS SPECIFIED)

10 UNDER	±0.2
10 OVER 30 UNDER	±0.25
30 OVER	±0.3
ANGULAR	±3 °

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE: MM ONLY	SCALE: 4:1	DESIGN UNITS: METRIC	THIRD ANGLE PROJECTION
DRAWN BY: T.UENO DATE: 2004/04/22	TITLE: 3.5 WIRE TO BOARD CONN -LEAD FREE-		
CHECKED BY: M.SASAO DATE: 2004/04/22			
APPROVED BY: M.SASAO DATE: 2004/04/22	MOLEX INCORPORATED		
MATERIAL NO.: SEE CHART	DOCUMENT NO.: SD-53258-005	SHEET NO.: 1 OF 1	

SIZE A3

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